





LSS SERIES

-SPEED HERMAPHRODITIC STRIP

SPECIFICATIONS

(0.635 mm) .025"

For complete specifications and recommended PCB layouts see www.samtec.com?LSS

Insulator Material:

Black Liquid Crystal Polymer Contact Material: Phosphor Bronze Plating: Au or Sn over 50 µ" (1.27 µm) Ni Current Rating:

1.7 A per pin (4 adjacent pins powered) Operating Temp Range: -55 °C to +125 °C RoHS Compliant:

PROCESSING

Lead-Free Solderable:

Yes SMT Lead Coplanarity: (0.10 mm) .004" max

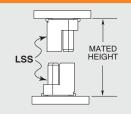
Board Stacking: For applications requiring two or more connectors per board, contact ipg@samtec.com

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



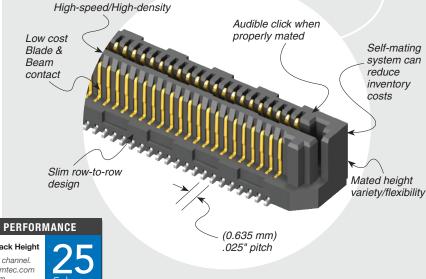
APPLICATION



LEAD STYLE	MATED HEIGHT*
-01 & -01	(6.00) .236
-01 & -03	(7.00) .276
-03 & -03	(8.00) .315
-01 & -02	(9.00) .354
-02 & -03	(10.00) .394
-02 & -02	(12.00) .472
*Processing conditions will affect mated height.	

Some lengths, styles and options are non-standard, non-returnable.

Mates with:



HIGH-SPEED CHANNEL PERFORMANCE

LSS-DV/LSS-DV @ 9 mm Mated Stack Height

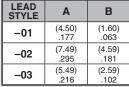
Rating based on Samtec reference channel. For full SI performance data visit Samtec.com or contact SIG@samtec.com

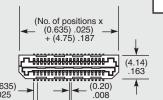


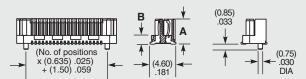
10, 20, 30, 40, 50

Specify LEAD **STYLE** from chart









PLATING

OPTION

-F = Gold flash on contact, Matte Tin on tail

> =10 μ" (0.25 μm) Gold on contact, Matte Tin on tail

= (3.50 mm) .138" DIA Polyimide film Pick & Place Pad

OPTION

–TR = Tape & Reel



- High retention contacts
- · Audible click when mated
- Shrouded

ALSO AVAILABLE (MOQ Required)

- Locking Clip on -02 or -03 lead style
- Other Gold plating options
- · Other pin counts

Due to technical progress, all designs, specifications and components are subject to change without notice